

CPC**COOPERATIVE PATENT CLASSIFICATION****H03H**

IMPEDANCE NETWORKS, e.g. RESONANT CIRCUITS; RESONATORS (measuring, testing [G01R](#); arrangements for producing a reverberation or echo sound [G10K 15/08](#); impedance networks or resonators consisting of distributed impedances, e.g. of the waveguide type, [H01P](#); control of amplification, e.g. bandwidth control of amplifiers, [H03G](#); tuning resonant circuits, e.g. tuning coupled resonant circuits, [H03J](#); networks for modifying the frequency characteristics of communication systems [H04B](#))

NOTES

1. This subclass covers :
 - networks comprising lumped impedance elements;
 - networks comprising distributed impedance elements together with lumped impedance elements;
 - networks comprising electromechanical or electro-acoustic elements;
 - networks simulating reactances and comprising discharge tubes or semiconductor devices;
 - constructions of electromechanical resonators.
2. In this subclass, the following expression is used with the meaning indicated: "passive elements" means resistors, capacitors, inductors, mutual inductors or diodes.
3. Attention is drawn to the Notes following the titles of class [B81](#) and subclass [B81B](#) relating to "micro-structural devices" and "micro-structural systems".
4. In this subclass, main groups with a higher number take precedence.

H03H 1/00

Constructional details of impedance networks whose electrical mode of operation is not specified or applicable to more than one type of network (constructional details of electromechanical transducers [H03H 9/00](#))

H03H 1/0007

- {of radio frequency interference filters}

H03H 2001/0014

- {Capacitor filters, i.e. capacitors whose parasitic inductance is of relevance to consider it as filter}

H03H 2001/0021

- {Constructional details}

H03H 2001/0028

- . {RFI filters with housing divided in two bodies}

H03H 2001/0035

- . {Wound magnetic core}

H03H 2001/0042

- . {Wound, ring or feed-through type capacitor}

H03H 2001/005

- . {Wound, ring or feed-through type inductor}

H03H 2001/0057

- . {comprising magnetic material}

H03H 2001/0064

- . {comprising semiconductor material}

H03H 2001/0071

- . {comprising zig-zag inductor}

H03H 2001/0078

- . {comprising spiral inductor on a substrate}

H03H 2001/0085

- . {Multilayer, e.g. LTCC, HTCC, green sheets (inside PCB filters [H05K](#))}

H03H 2001/0092

- {Inductor filters, i.e. inductors whose parasitic capacitance is of relevance to consider it as filter}

H03H 1/02

- of RC networks, e.g. integrated networks

H03H 2/00 **Networks using elements or techniques not provided for in groups [H03H 3/00](#) to [H03H 21/00](#)**

- H03H 2/001 . {comprising magnetostatic wave network elements}
- H03H 2/003 . {comprising optical fibre network elements (optical elements per se [G02B](#), [G02F](#); transmission systems using light waves [H04B 10/00](#))}
- H03H 2/005 . {Coupling circuits between transmission lines or antennas and transmitters, receivers or amplifiers}
- H03H 2/006 . . {Transmitter or amplifier output circuits}
- H03H 2/008 . . {Receiver or amplifier input circuits}

H03H 3/00 **Apparatus or processes specially adapted for the manufacture of impedance networks, resonating circuits, resonators**

- H03H 3/007 . for the manufacture of electromechanical resonators or networks
- H03H 2003/0071 . . {of bulk acoustic wave and surface acoustic wave elements in the same process}
- H03H 3/0072 . . {of micro-electro-mechanical resonators or networks (micro-membranes or micro-beams [B81B 2203/01](#); manufacture of micro-structural devices in general [B81C](#))}
- H03H 3/0073 . . . {Integration with other electronic structures}
- H03H 3/0075 . . . {Arrangements or methods specially adapted for testing micro-electro-mechanical resonators or networks}
- H03H 3/0076 . . . {for obtaining desired frequency or temperature coefficients}
- H03H 3/0077 {by tuning of resonance frequency}
- H03H 3/0078 {involving adjustment of the transducing gap}
- H03H 3/013 . . for obtaining desired frequency or temperature coefficient (([H03H 3/0076](#)) [H03H 3/04](#), [H03H 3/10](#) take precedence)
- H03H 3/02 . . for the manufacture of piezo-electric or electrostrictive resonators or networks ([H03H 3/08](#) takes precedence)
- H03H 2003/021 . . . {the resonators or networks being of the air-gap type}
- H03H 2003/022 . . . {the resonators or networks being of the cantilever type}
- H03H 2003/023 . . . {the resonators or networks being of the membrane type}
- H03H 2003/025 . . . {the resonators or networks comprising an acoustic mirror}
- H03H 2003/026 . . . {the resonators or networks being of the tuning fork type}
- H03H 2003/027 . . . {the resonators or networks being of the micro-electro-mechanical [MEMS] type}
- H03H 2003/028 . . . {for obtaining desired values of other parameters}
- H03H 3/04 . . . for obtaining desired frequency or temperature coefficient
- H03H 2003/0407 {Temperature coefficient}
- H03H 2003/0414 {Resonance frequency}
- H03H 2003/0421 {Modification of the thickness of an element}
- H03H 2003/0428 {of an electrode}
- H03H 2003/0435 {of a piezoelectric layer}
- H03H 2003/0442 {of a non-piezoelectric layer}

- H03H 2003/045 {Modification of the area of an element}
- H03H 2003/0457 {of an electrode}
- H03H 2003/0464 {operating on an additional circuit element, e.g. a passive circuit element connected to the resonator}
- H03H 2003/0471 {of a plurality of resonators at different frequencies}
- H03H 2003/0478 {in a process for mass production}
- H03H 2003/0485 {during the manufacture of a cantilever}
- H03H 2003/0492 {during the manufacture of a tuning-fork}
- H03H 3/06 . . for the manufacture of magnetostrictive resonators or networks
- H03H 3/08 . . for the manufacture of resonators or networks using surface acoustic waves
- H03H 3/10 . . . for obtaining desired frequency or temperature coefficient

H03H 5/00 One-port networks comprising only passive electrical elements as network components

- H03H 5/003 . {comprising distributed impedance elements together with lumped impedance elements}
- H03H 5/006 . {comprising simultaneously tunable inductance and capacitance}
- H03H 5/02 . without voltage- or current-dependent elements
- H03H 5/10 . . comprising at least one element with prescribed temperature coefficient
- H03H 5/12 . with at least one voltage- or current-dependent element

H03H 7/00 Multiple-port networks comprising only passive electrical elements as network components (receiver input circuits [H04B 1/18](#); networks simulating a length of communication cable [H04B 3/40](#))

- H03H 7/002 . {Gyrators}
- H03H 7/004 . {Capacitive coupling circuits not otherwise provided for}
- H03H 2007/006 . {MEMS}
- H03H 2007/008 . . {the MEMS being trimmable}
- H03H 7/01 . Frequency selective two-port networks
- H03H 7/0107 . . {Non-linear filters}
- H03H 7/0115 . . {comprising only inductors and capacitors ([H03H 7/075](#), [H03H 7/09](#), [H03H 7/12](#), [H03H 7/13](#) take precedence)}
- H03H 7/0123 . . {comprising distributed impedance elements together with lumped impedance elements}
- H03H 2007/013 . . {Notch or bandstop filters}
- H03H 7/0138 . . {Electrical filters or coupling circuits}
- H03H 7/0146 . . . {Coupling circuits between two tubes, not otherwise provided for}
- H03H 7/0153 . . {Electrical filters; Controlling thereof}
- H03H 7/0161 . . . {Bandpass filters ([H03H 7/12](#) takes precedence)}
- H03H 7/0169 {Intermediate frequency filters}
- H03H 7/0176 {without magnetic core}
- H03H 7/0184 {with ferromagnetic core}
- H03H 2007/0192 . . {Complex filters}

- H03H 7/03 . . . comprising means for compensation of loss
 - H03H 7/06 . . . including resistors ([H03H 7/075](#), [H03H 7/09](#), [H03H 7/12](#), [H03H 7/13](#) take precedence)
 - H03H 7/065 Parallel T-filters
 - H03H 7/07 Bridged T-filters
 - H03H 7/075 . . . Ladder networks, e.g. electric wave filters
 - H03H 7/09 . . . Filters comprising mutual inductance
 - H03H 7/12 . . . Bandpass or bandstop filters with adjustable bandwidth and fixed centre frequency ([H03H 7/09](#) takes precedence; automatic control of bandwidth in amplifiers [H03G 5/16](#))
 - H03H 7/13 . . . using electro-optic elements
 - H03H 7/17 . . . {Structural details of sub-circuits of frequency selective networks}
- WARNING**
- not complete, pending reorganisation, see provisionally also [H03H 7/0107](#), [H03H 7/0123](#) to [H03H 7/07](#), [H03H 7/09](#) to [H03H 7/13](#) and [H03H 7/42](#)
- H03H 7/1708 {Comprising bridging elements, i.e. elements in a series path without own reference to ground and spanning branching nodes of another series path ([H03H 7/07](#) takes precedence)}
 - H03H 7/1716 {Comprising foot-point elements}
 - H03H 7/1725 {Element to ground being common to different shunt paths, i.e. Y-structure}
 - H03H 7/1733 {Element between different shunt or branch paths ([H03H 7/425](#) takes precedence)}
 - H03H 7/1741 {Comprising typical LC combinations, irrespective of presence and location of additional resistors (when resistors are present, also classify in [H03H 7/06](#) to [H03H 7/07](#))}
 - H03H 7/175 {Series LC in series path ([H03H 7/1783](#) takes precedence)}
 - H03H 7/1758 {Series LC in shunt or branch path ([H03H 7/1791](#) takes precedence)}
 - H03H 7/1766 {Parallel LC in series path ([H03H 7/1783](#) takes precedence)}
 - H03H 7/1775 {Parallel LC in shunt or branch path ([H03H 7/1791](#) takes precedence)}
 - H03H 7/1783 {Combined LC in series path}
 - H03H 7/1791 {Combined LC in shunt or branch path}
 - H03H 7/18 . . . Networks for phase shifting
 - H03H 7/185 . . . {comprising distributed impedance elements together with lumped impedance elements}
 - H03H 7/19 . . . Two-port phase shifters providing a predetermined phase shift, e.g. "all-pass" filters
 - H03H 7/20 . . . Two-port phase shifters providing an adjustable phase shift
 - H03H 7/21 . . . providing two or more phase shifted output signals, e.g. n-phase output
 - H03H 7/24 . . . Frequency- independent attenuators
 - H03H 7/25 . . . comprising an element controlled by an electric or magnetic variable ([H03H 7/27](#) takes precedence)

- H03H 7/251 . . . {the element being a thermistor}
 - H03H 7/253 . . . {the element being a diode}
 - H03H 7/255 {the element being a PIN diode}
 - H03H 7/256 {the element being a VARACTOR diode}
 - H03H 7/258 . . . {using a galvano-magnetic device}
 - H03H 7/27 . . comprising a photo-electric element
 - H03H 7/30 . Time-delay networks {(analogue shift registers [G11C 27/04](#))}
 - H03H 7/32 . . with lumped inductance and capacitance
 - H03H 7/325 . . . {Adjustable networks}
 - H03H 7/34 . . with lumped and distributed reactance
 - H03H 7/345 . . . {Adjustable networks}
 - H03H 7/38 . Impedance-matching networks
 - H03H 7/383 . . {comprising distributed impedance elements together with lumped impedance elements}
 - H03H 2007/386 . . {Multiple band impedance matching}
 - H03H 7/40 . . Automatic matching of load impedance to source impedance
 - H03H 7/42 . Balance/unbalance networks
 - H03H 7/422 . . {comprising distributed impedance elements together with lumped impedance elements}
 - H03H 7/425 . . {Balance-balance networks}
- WARNING**
- not complete, pending reorganisation, see provisionally also [H03H 1/00](#) to [H03H 1/0007](#), [H03H 7/0107](#), [H03H 7/0123](#) to [H03H 7/07](#), [H03H 7/09](#) to [H03H 7/13](#), [H03H 7/42](#) and [H03H 7/422](#)
- H03H 7/427 . . . {Common-mode filters ([H02J 3/01](#) and [H02M 1/126](#) takes precedence)}
- WARNING**
- not complete, pending reorganisation, see provisionally also [H03H 1/00](#) to [H03H 1/0007](#), [H03H 7/0107](#), [H03H 7/0123](#) to [H03H 7/07](#), [H03H 7/09](#) to [H03H 7/13](#) and [H03H 7/42](#)
- H03H 7/46 . Networks for connecting several sources or loads, working on different frequencies or frequency bands, to a common load or source (for use in multiplex transmission systems [H04J 1/00](#))
 - H03H 7/461 . . {particularly adapted for use in common antenna systems}
 - H03H 7/463 . . {Duplexers}
 - H03H 7/465 . . . {having variable circuit topology, e.g. including switches}
 - H03H 7/466 . . {particularly adapted as input circuit for receivers}
 - H03H 7/468 . . {particularly adapted as coupling circuit between transmitters and antennas}
 - H03H 7/48 . Networks for connecting several sources or loads, working on the same frequency or frequency band, to a common load or source (phase shifters providing two or more output signals [H03H 7/21](#))
 - H03H 7/482 . . {particularly adapted for use in common antenna systems}
 - H03H 7/485 . . {particularly adapted as input circuit for receivers}

- H03H 7/487 . . {particularly adapted as coupling circuit between transmitters and antennas}
- H03H 7/52 . One-way transmission networks, i.e. unilines
- H03H 7/54 . Modifications of networks to reduce influence of variations of temperature

H03H 9/00

Networks comprising electromechanical or electro-acoustic devices;
Electromechanical resonators (making single crystals [C30B](#); selection of materials thereof [H01L](#); piezo-electric, electrostrictive or magnetostrictive devices per se [H01L 41/00](#); electromechanical transducers [H04R](#))

- H03H 9/0004 . {Impedance-matching networks ([H03H 9/145](#) takes precedence)}
- H03H 9/0009 . . {using surface acoustic wave devices}
- H03H 9/0014 . . {using bulk acoustic wave devices}
- H03H 2009/0019 . {Surface acoustic wave multichip}
- H03H 9/0023 . {Balance-unbalance or balance-balance networks}
- H03H 9/0028 . . {using surface acoustic wave devices}
- H03H 9/0033 . . . {having one acoustic track only}
- H03H 9/0038 {the balanced terminals being on the same side of the track}
- H03H 9/0042 {the balanced terminals being on opposite sides of the track}
- H03H 9/0047 . . . {having two acoustic tracks ([H03H 9/008](#), [H03H 9/0085](#) take precedence)}
- H03H 9/0052 {being electrically cascaded}
- H03H 9/0057 {the balanced terminals being on the same side of the tracks}
- H03H 9/0061 {the balanced terminals being on opposite sides of the tracks}
- H03H 9/0066 {being electrically parallel}
- H03H 9/0071 {the balanced terminals being on the same side of the tracks}
- H03H 9/0076 {the balanced terminals being on opposite sides of the tracks}
- H03H 9/008 . . . {having three acoustic tracks ([H03H 9/0085](#) takes precedence)}
- H03H 9/0085 . . . {having four acoustic tracks}
- H03H 9/009 {Lattice filters}
- H03H 9/0095 . . {using bulk acoustic wave devices}
- H03H 9/02 . Details
- H03H 9/02007 . . {of bulk acoustic wave devices}
- H03H 9/02015 . . . {Characteristics of piezoelectric layers, e.g. cutting angles}
- H03H 9/02023 {consisting of quartz}
- H03H 9/02031 {consisting of ceramic}
- H03H 9/02039 {consisting of a material from the crystal group 32, e.g. langasite, langatate, langanite}
- H03H 9/02047 . . . {Treatment of substrates}
- H03H 9/02055 {of the surface including the back surface}
- H03H 9/02062 . . . {Details relating to the vibration mode}
- H03H 9/0207 {the vibration mode being harmonic}
- H03H 9/02078 {the vibration mode being overmoded}
- H03H 9/02086 . . . {Means for compensation or elimination of undesirable effects}

H03H 9/02094	{of adherence}
H03H 9/02102	{of temperature influence (cutting angles H03H 9/02015)}
H03H 9/0211	{of reflections}
H03H 9/02118	{of lateral leakage between adjacent resonators}
H03H 9/02125	{of parasitic elements}
H03H 9/02133	{of stress}
H03H 9/02141	{of electric discharge due to pyroelectricity}
H03H 9/02149	{of ageing changes of characteristics, e.g. electro-acousto-migration}
H03H 9/02157	. . .	{Dimensional parameters, e.g. ratio between two dimension parameters, length, width or thickness}
H03H 2009/02165	. .	{Tuning}
H03H 2009/02173	. . .	{of film bulk acoustic resonators [FBAR]}
H03H 2009/02181	{by application of heat from a heat source}
H03H 2009/02188	{Electrically tuning}
H03H 2009/02196	{operating on the FBAR element, e.g. by direct application of a tuning DC voltage}
H03H 2009/02204	{operating on an additional circuit element, e.g. applying a tuning DC voltage to a passive circuit element connected to the resonator}
H03H 2009/02212	{Magnetically tuning}
H03H 9/0222	. .	{of interface-acoustic, boundary, pseudo-acoustic or Stonely wave devices}
H03H 9/02228	. .	{Guided bulk acoustic wave devices or Lamb wave devices having interdigital transducers situated in parallel planes on either side of a piezoelectric layer}
H03H 9/02236	. .	{of surface skimming bulk wave devices}
H03H 9/02244	. .	{of micro-electro-mechanical resonators}
H03H 2009/02251	. . .	{Design}
H03H 9/02259	. . .	{Driving or detection means}
H03H 2009/02267	{having dimensions of atomic scale, e.g. involving electron transfer across vibration gap}
H03H 9/02275	{Comb electrodes}
H03H 2009/02283	. . .	{Vibrating means}
H03H 2009/02291	{Beams}
H03H 2009/02299	{Comb-like, i.e. the beam comprising a plurality of fingers or protrusions along its length}
H03H 2009/02307	{Dog-bone-like structure, i.e. the elongated part of the "bone" is doubly clamped}
H03H 2009/02314	{forming part of a transistor structure}
H03H 2009/02322	{Material}
H03H 2009/0233	{comprising perforations}
H03H 9/02338	. . .	{Suspension means}
H03H 2009/02346	{Anchors for ring resonators}

H03H 2009/02354	{applied along the periphery, e.g. at nodal points of the ring}
H03H 9/02362	{Folded-flexure}
H03H 2009/0237	{applied at the center}
H03H 9/02377	{Symmetric folded-flexure}
H03H 2009/02385	{Anchors for square resonators, i.e. resonators comprising a square vibrating membrane}
H03H 9/02393	{Post-fabrication trimming of parameters, e.g. resonance frequency, Q factor}
H03H 9/02401	{by annealing}
H03H 9/02409	{by application of a DC-bias voltage (H03H 9/02417 takes precedence)}
H03H 9/02417	{involving adjustment of the transducing gap}
H03H 9/02425	{by electrostatically pulling the beam}
H03H 9/02433	{Means for compensation or elimination of undesired effects}
H03H 2009/0244	{Anchor loss}
H03H 9/02448	{of temperature influence}
H03H 2009/02456	{Parasitic elements or effects, e.g. parasitic capacitive coupling between input and output}
H03H 2009/02464	{Pull-in}
H03H 2009/02472	{Stiction}
H03H 2009/0248	{Strain}
H03H 2009/02488	{Vibration modes}
H03H 2009/02496	{Horizontal, i.e. parallel to the substrate plane}
H03H 2009/02503	{Breath-like, e.g. Lamé mode, wine-glass mode}
H03H 2009/02511	{Vertical, i.e. perpendicular to the substrate plane}
H03H 2009/02519	{Torsional}
H03H 2009/02527	{Combined}
H03H 9/02535	{of surface acoustic wave devices}
H03H 9/02543	{Characteristics of substrate, e.g. cutting angles}
H03H 9/02551	{of quartz substrates}
H03H 9/02559	{of lithium niobate or lithium-tantalate substrates}
H03H 9/02566	{of semiconductor substrates}
H03H 9/02574	{of combined substrates, multilayered substrates, piezo-electrical layers on not-piezo- electrical substrate}
H03H 9/02582	{of diamond substrates}
H03H 9/0259	{of langasite substrates}
H03H 9/02598	{of langatate substrates}
H03H 9/02606	{of langanite substrates}
H03H 9/02614	{Treatment of substrates, e.g. curved, spherical, cylindrical substrates ensuring closed round-about circuits for the acoustical waves}
H03H 9/02622	{of the surface, including back surface}
H03H 9/02629	{of the edges}

H03H 9/02637	. . .	{Details concerning reflective or coupling arrays}
H03H 9/02645	{Waffle-iron or dot arrays}
H03H 9/02653	{Grooves or arrays buried in the substrate}
H03H 9/02661	{being located inside the interdigital transducers}
H03H 9/02669	{Edge reflection structures, i.e. resonating structures without metallic reflectors, e.g. Bleustein-Gulyaev-Shimizu [BGS], shear horizontal [SH], shear transverse [ST], Love waves devices}
H03H 9/02677	{having specially shaped edges, e.g. stepped, U-shaped edges}
H03H 9/02685	{Grating lines having particular arrangements}
H03H 9/02692	{Arched grating lines}
H03H 9/027	{U-shaped grating lines}
H03H 9/02708	{Shifted grating lines}
H03H 9/02716	{Tilted, fan shaped or slanted grating lines}
H03H 9/02724	{Comb like grating lines}
H03H 9/02732	{Bilateral comb like grating lines}
H03H 9/0274	{Intra-transducers grating lines}
H03H 9/02748	{Dog-legged reflectors}
H03H 9/02755	{Meandering floating or grounded grating lines}
H03H 9/02763	{Left and right side electrically coupled reflectors}
H03H 9/02771	{Reflector banks}
H03H 9/02779	{Continuous surface reflective arrays}
H03H 9/02787	{having wave guide like arrangements}
H03H 9/02795	{Multi-strip couplers as track changers}
H03H 9/02803	{Weighted reflective structures}
H03H 9/02811	{Chirped reflective or coupling arrays}
H03H 9/02818	. . .	{Means for compensation or elimination of undesirable effects}
H03H 9/02826	{of adherence}
H03H 9/02834	{of temperature influence (cut angles H03H 9/02543)}
H03H 9/02842	{of reflections (H03H 9/6406 takes precedence)}
H03H 9/0285	{of triple transit echo}
H03H 9/02858	{of wave front distortion}
H03H 9/02866	{of bulk wave excitation and reflections}
H03H 9/02874	{of direct coupling between input and output transducers}
H03H 9/02881	{of diffraction of wave beam}
H03H 9/02889	{of influence of mass loading}
H03H 9/02897	{of strain or mechanical damage, e.g. strain due to bending influence}
H03H 9/02905	{Measures for separating propagation paths on substrate}
H03H 9/02913	{Measures for shielding against electromagnetic fields (shielding of electrical components in general H05K 9/00)}
H03H 9/02921	{Measures for preventing electric discharge due to pyroelectricity}
H03H 9/02929	{of ageing changes of characteristics, e.g. electro-acousto-migration}

H03H 9/02937 {of chemical damage, e.g. corrosion}
H03H 9/02944 {of ohmic loss}
H03H 9/02952 {of parasitic capacitance}
H03H 9/0296	. . . {Surface acoustic wave [SAW] devices having both acoustic and non-acoustic properties}
H03H 9/02968 {with optical devices (mounting in enclosures H03H 9/12)}
H03H 9/02976 {with semiconductor devices}
H03H 9/02984	. . . {Protection measures against damaging}
H03H 9/02992	. . . {Details of bus bars, contact pads or other electrical connections for finger electrodes}
H03H 9/05	. . Holders; Supports
H03H 9/0504	. . . {for bulk acoustic wave devices}
H03H 9/0509 {consisting of adhesive elements}
H03H 9/0514 {consisting of mounting pads or bumps}
H03H 9/0519 {for cantilever (H03H 9/1021 takes precedence)}
H03H 9/0523 {for flip-chip mounting}
H03H 9/0528 {consisting of clips}
H03H 9/0533 {consisting of wire}
H03H 9/0538	. . . {Constructional combinations of supports or holders with electromechanical or other electronic elements}
H03H 9/0542 {consisting of a lateral arrangement (H03H 9/0566 takes precedence)}
H03H 9/0547 {consisting of a vertical arrangement (H03H 9/0566 takes precedence)}
H03H 9/0552 {the device and the other elements being mounted on opposite sides of a common substrate}
H03H 9/0557 {the other elements being buried in the substrate}
H03H 9/0561 {consisting of a multilayered structure}
H03H 9/0566 {for duplexers}
H03H 9/0571 {including bulk acoustic wave [BAW] devices}
H03H 9/0576 {including surface acoustic wave [SAW] devices}
H03H 9/058	. . . {for surface acoustic wave devices}
H03H 9/0585 {consisting of an adhesive layer}
H03H 9/059 {consisting of mounting pads or bumps}
H03H 9/0595	. . . {the holder support and resonator being formed in one body}
H03H 9/08	. . . Holders with means for regulating temperature
H03H 9/09	. . . Elastic or damping supports
H03H 9/10	. . . Mounting in enclosures {(constructional combinations of enclosure with electromechanical and other electronic elements H03H 9/0538)}
H03H 9/1007 {for bulk acoustic wave [BAW] devices}
H03H 9/1014 {the enclosure being defined by a frame built on a substrate and a cap, the frame having no mechanical contact with the BAW device}
H03H 9/1021 {the BAW device being of the cantilever type}

H03H 9/1028 {the BAW device being held between spring terminals}
H03H 9/1035 {the enclosure being defined by two sealing substrates sandwiching the piezoelectric layer of the BAW device}
H03H 9/1042 {the enclosure being defined by a housing formed by a cavity in a resin}
H03H 9/105 {the enclosure being defined by a cover cap mounted on an element forming part of the BAW device}
H03H 9/1057 {for micro-electro-mechanical devices}
H03H 9/1064 {for surface acoustic wave [SAW] devices}
H03H 9/1071 {the enclosure being defined by a frame built on a substrate and a cap, the frame having no mechanical contact with the SAW device}
H03H 9/1078 {the enclosure being defined by a foil covering the non-active sides of the SAW device}
H03H 9/1085 {the enclosure being defined by a non-uniform sealing mass covering the non-active sides of the BAW device}
H03H 9/1092 {the enclosure being defined by a cover cap mounted on an element forming part of the surface acoustic wave [SAW] device on the side of the IDT's}
H03H 9/12 for networks with interaction of optical and acoustic waves
H03H 9/125	. . . Driving means, e.g. electrodes, coils
H03H 9/13	. . . for networks consisting of piezo-electric or electrostrictive materials (H03H 9/145 takes precedence)
H03H 9/131 {consisting of a multilayered structure}
H03H 9/132 {characterized by a particular shape}
H03H 9/133 {for electromechanical delay lines or filters}
H03H 9/135	. . . for networks consisting of magnetostrictive materials (H03H 9/145 takes precedence)
H03H 9/145	. . . for networks using surface acoustic waves
H03H 9/14502 {Surface acoustic wave [SAW] transducers for a particular purpose}
H03H 9/14505 {Unidirectional SAW transducers}
H03H 9/14508 {Polyphase SAW transducers}
H03H 9/14511 {SAW transducers for non-piezoelectric substrates}
H03H 9/14514 {Broad band transducers}
H03H 9/14517 {Means for weighting}
H03H 9/1452 {by finger overlap length, apodisation}
H03H 9/14523 {Capacitive tap weighted transducers}
H03H 9/14526 {Finger withdrawal}
H03H 9/14529 {Distributed tap}
H03H 9/14532 {Series weighting; Transverse weighting}
H03H 9/14535 {Position weighting}
H03H 9/14538 {Formation}
H03H 9/14541 {Multilayer finger or busbar electrode}

H03H 9/14544 {Transducers of particular shape or position (weighting H03H 9/14517)}
H03H 9/14547 {Fan shaped; Tilted; Shifted; Slanted; Tapered; Arched; Stepped finger transducers}
H03H 9/1455 {constituted of N parallel or series transducers}
H03H 9/14552 {comprising split fingers}
H03H 9/14555 {Chirped transducers (H03H 9/6406 takes precedence)}
H03H 9/14558 {Slanted, tapered or fan shaped transducers (H03H 9/14561, H03H 9/14564 take precedence)}
H03H 9/14561 {Arched, curved or ring shaped transducers}
H03H 9/14564 {Shifted fingers transducers}
H03H 9/14567 {Stepped-fan shaped transducers}
H03H 9/1457 {Transducers having different finger widths}
H03H 9/14573 {Arrow type transducers}
H03H 9/14576 {Transducers whereby only the last fingers have different characteristics with respect to the other fingers, e.g. different shape, thickness or material, split finger}
H03H 9/14579 {the last fingers having a different shape}
H03H 9/14582 {the last fingers having a different pitch}
H03H 9/14585 {the last fingers being split}
H03H 9/14588 {Horizontally-split transducers}
H03H 9/14591 {Vertically-split transducers}
H03H 9/14594 {Plan-rotated or plan-tilted transducers}
H03H 9/14597 {Matching SAW transducers to external electrical circuits}
H03H 9/15	. Constructional features of resonators consisting of piezo-electric or electrostrictive material (H03H 9/25 takes precedence)
H03H 2009/155	. . {using MEMS techniques}
H03H 9/17	. . having a single resonator (crystal tuning forks H03H 9/21)
H03H 9/171	. . . {implemented with thin-film techniques, i.e. of the film bulk acoustic resonator [FBAR] type}
H03H 9/172 {Means for mounting on a substrate, i.e. means constituting the material interface confining the waves to a volume}
H03H 9/173 {Air-gaps}
H03H 9/174 {Membranes}
H03H 9/175 {Acoustic mirrors}
H03H 9/176	. . . {consisting of ceramic material (H03H 9/177, H03H 9/178 take precedence)}
H03H 9/177	. . . {of the energy-trap type}
H03H 9/178	. . . {of a laminated structure of multiple piezoelectric layers with inner electrodes}
H03H 9/19	. . . consisting of quartz
H03H 9/205	. . having multiple resonators (crystal tuning forks H03H 9/21)
H03H 9/21	. . Crystal tuning forks

- H03H 9/215 . . . consisting of quartz
- H03H 9/22 . Constructional features of resonators consisting of magnetostrictive material
- H03H 9/24 . Constructional features of resonators of material which is not piezo-electric, electrostrictive, or magnetostrictive
- H03H 9/2405 . . {of micro-electro-mechanical resonators}
- H03H 2009/241 . . . {Bulk-mode MEMS resonators}
- H03H 2009/2415 {with concave shape [CBAR]}
- H03H 2009/2421 {with I shape [IBAR]}
- H03H 9/2426 . . . {in combination with other electronic elements}
- H03H 9/2431 . . . {Ring resonators}
- H03H 9/2436 . . . {Disk resonators}
- H03H 2009/2442 . . . {Square resonators}
- H03H 9/2447 . . . {Beam resonators ([H03H 9/2468](#) takes precedence)}
- H03H 9/2452 {Free-free beam resonators}
- H03H 9/2457 {Clamped-free beam resonators}
- H03H 9/2463 {Clamped-clamped beam resonators}
- H03H 9/2468 . . . {Tuning fork resonators}
- H03H 9/2473 {Double-Ended Tuning Fork [DETF] resonators}
- H03H 9/2478 {Single-Ended Tuning Fork resonators}
- H03H 9/2484 {with two fork tines, e.g. Y-beam cantilever}
- H03H 9/2489 {with more than two fork tines}
- H03H 9/2494 {H-shaped, i.e. two tuning forks with common base}
- H03H 9/25 . Constructional features of resonators using surface acoustic waves {(devices for manipulating acoustic surface waves in general [G10K 11/36](#))}
- H03H 9/30 . Time-delay networks
- H03H 9/36 . . with non-adjustable delay time ([H03H 9/40](#), [H03H 9/42](#) take precedence)
- H03H 9/38 . . with adjustable delay time ([H03H 9/40](#), [H03H 9/42](#) take precedence)
- H03H 9/40 . . Frequency dependent delay lines, e.g. dispersive delay lines ([H03H 9/42](#) takes precedence)
- H03H 9/42 . . using surface acoustic waves {(devices for manipulating acoustic surface waves in general [G10K 11/36](#))}
- H03H 9/423 . . . {with adjustable delay time}
- H03H 9/426 . . . {Magneto-elastic surface waves}
- H03H 9/44 . . . Frequency dependent delay lines, e.g. dispersive delay lines
- H03H 9/46 . Filters (multiple-port electromechanical filters [H03H 9/70](#))
- H03H 9/462 . . {Micro-electro-mechanical filters}
- H03H 9/465 . . . {in combination with other electronic elements}
- H03H 9/467 . . . {Post-fabrication trimming of parameters, e.g. center frequency}
- H03H 9/48 . . Coupling means therefor
- H03H 9/485 . . . {for micro-electro-mechanical filters}
- H03H 9/50 . . . Mechanical coupling means

- H03H 9/505 {for micro-electro-mechanical filters}
- H03H 9/52 . . . Electric coupling means
- H03H 9/525 {for micro-electro-mechanical filters}
- H03H 9/54 . . comprising resonators of piezo-electric or electrostrictive material
(H03H 9/64 takes precedence)
- H03H 9/542 . . . {including passive elements (H03H 9/545 takes precedence)}
- H03H 9/545 . . . {including active elements}
- H03H 9/547 . . . {Notch filters, e.g. notch BAW or thin film resonator filters}
- H03H 9/56 . . . Monolithic crystal filters
- H03H 9/562 {comprising a ceramic piezoelectric layer}
- H03H 9/564 {implemented with thin-film techniques}
- H03H 9/566 {Electric coupling means therefor (H03H 9/0095 takes precedence)}
- H03H 9/568 {consisting of a ladder configuration}
- H03H 9/58 . . . Multiple crystal filters
- H03H 9/581 {comprising ceramic piezoelectric layers}
- H03H 9/582 {implemented with thin-film techniques}
- H03H 9/583 {comprising a plurality of piezoelectric layers acoustically coupled}
- H03H 9/584 {Coupled Resonator Filters [CFR]}
- H03H 9/585 {Stacked Crystal Filters [SCF]}
- H03H 9/586 {Means for mounting to a substrate, i.e. means constituting the
material interface confining the waves to a volume}
- H03H 9/587 {Air-gaps}
- H03H 9/588 {Membranes}
- H03H 9/589 {Acoustic mirrors}
- H03H 9/60 Electric coupling means therefor {(H03H 9/0095 takes precedence)}
- H03H 9/605 {consisting of a ladder configuration}
- H03H 9/62 . . comprising resonators of magnetostrictive material (H03H 9/64 takes
precedence)
- H03H 9/64 . . using surface acoustic waves
- H03H 9/6403 . . . {Programmable filters}
- H03H 9/6406 . . . {Filters characterised by a particular frequency characteristic}
- H03H 9/6409 {SAW notch filters}
- H03H 9/6413 {SAW comb filters}
- H03H 9/6416 {SAW matched filters, e.g. surface acoustic wave compressors,
chirped or coded surface acoustic wave filters}
- H03H 9/642 {SAW transducers details for remote interrogation systems, e.g.
surface acoustic wave transducers details for ID-tags (remote
interrogation systems per se G06K 7/10009, G01S 13/74)}
- H03H 9/6423 . . . {Means for obtaining a particular transfer characteristic}
- H03H 9/6426 {Combinations of the characteristics of different transducers}
- H03H 9/643 {the transfer characteristic being determined by reflective or coupling
array characteristics}

H03H 9/6433 {Coupled resonator filters}
H03H 9/6436 {having one acoustic track only}
H03H 9/644 {having two acoustic tracks}
H03H 9/6443 {being acoustically coupled}
H03H 9/6446 {by floating multistrip couplers (H03H 9/645 , H03H 9/6453 take precedence)}
H03H 9/645 {by grating reflectors overlapping both tracks}
H03H 9/6453 {by at least an interdigital transducer overlapping both tracks}
H03H 9/6456 {being electrically coupled}
H03H 9/6459 {via one connecting electrode}
H03H 9/6463 {the tracks being electrically cascaded}
H03H 9/6466 {each track containing more than two transducers}
H03H 9/6469 {via two connecting electrodes}
H03H 9/6473 {the electrodes being electrically interconnected}
H03H 9/6476 {the tracks being electrically parallel}
H03H 9/6479 {Capacitively coupled SAW resonator filters}
H03H 9/6483 {Ladder SAW filters}
H03H 9/6486 {having crossing or intersecting acoustic tracks, e.g. intersection in a perpendicular or diagonal orientation}
H03H 9/6489	. . . {Compensation of undesirable effects}
H03H 9/6493 {Side lobe suppression}
H03H 9/6496 {Reducing ripple in transfer characteristic}
H03H 9/66	. Phase shifters
H03H 9/68	. . using surface acoustic waves
H03H 9/70	. Multiple-port networks for connecting several sources or loads, working on different frequencies or frequency bands, to a common load or source
H03H 9/703	. . {Networks using bulk acoustic wave devices}
H03H 9/706	. . . {Duplexers}
H03H 9/72	. . Networks using surface acoustic waves
H03H 9/725	. . . {Duplexers}
H03H 9/74	. Multiple-port networks for connecting several sources or loads, working on the same frequency or frequency band, to a common load or source (networks for phase shifting H03H 9/66)
H03H 9/76	. . Networks using surface acoustic waves
H03H 11/00	Networks using active elements
H03H 11/02	. Multiple-port networks
H03H 11/025	. . {using current conveyors}
H03H 11/04	. . Frequency selective two-port networks
H03H 11/0405	. . . {Non-linear filters}
H03H 2011/0411 {Rank order or median filters}

H03H 11/0416	. . .	{using positive impedance converters (H03H 11/08 takes precedence)}
H03H 11/0422	. . .	{using transconductance amplifiers, e.g. gmC filters}
H03H 11/0427	{Filters using a single transconductance amplifier; Filters derived from a single transconductor filter, e.g. by element substitution, cascading, parallel connection (H03H 11/0433 to H03H 11/0472 take precedence)}
H03H 11/0433	{Two integrator loop filters (H03H 11/0455 takes precedence)}
H03H 11/0438	{Tow-Thomas biquad}
H03H 11/0444	{Simulation of ladder networks}
H03H 11/045	{Leapfrog structures}
H03H 11/0455	{Multiple integrator loop feedback filters}
H03H 11/0461	{Current mode filters}
H03H 11/0466	{Filters combining transconductance amplifiers with other active elements, e.g. operational amplifiers, transistors, voltage conveyors}
H03H 11/0472	{Current or voltage controlled filters}
H03H 2011/0477	. . .	{using current feedback operational amplifiers}
H03H 2011/0483	. . .	{using operational transresistance amplifiers [OTRA]}
H03H 2011/0488	. . .	{Notch or bandstop filters}
H03H 2011/0494	. . .	{Complex filters}
H03H 11/06	. . .	comprising means for compensation of loss
H03H 11/08	. . .	using gyrators
H03H 11/10	. . .	using negative impedance converters (H03H 11/08 takes precedence)
H03H 11/11	. . .	{using current conveyors}
H03H 11/12	. . .	using amplifiers with feedback (H03H 11/0422 , H03H 11/08 , H03H 11/10 take precedence)
H03H 11/1204	{Distributed RC filters}
H03H 11/1208	{comprising an electromechanical resonator}
H03H 11/1213	{using transistor amplifiers (H03H 11/1204 takes precedence; parallel-T filters H03H 11/1295)}
H03H 11/1217	{using a plurality of operational amplifiers (H03H 11/1204 takes precedence; parallel-T filters H03H 11/1295)}
H03H 11/1221	{Theory; Synthesis (H03H 11/1226 to H03H 11/1252 take precedence)}
H03H 11/1226	{Filters using operational amplifier poles}
H03H 11/123	{Modifications to reduce sensitivity}
H03H 11/1234	{Modifications to reduce detrimental influences of amplifier imperfections, e.g. limited gain-bandwidth product, limited input impedance}
H03H 11/1239	{Modifications to reduce influence of variations of temperature}
H03H 11/1243	{Simulation of ladder networks}
H03H 11/1247	{Leapfrog structures}

WARNING

H03H 11/1247

(continued)

Not complete, pending reorganisation, see provisionally
also [H03H 11/1217](#) to [H03H 11/1252](#)

H03H 11/1252 {Two integrator-loop-filters}

H03H 11/1256 {Tow-Thomas biquad}

WARNING

Not complete, pending reorganisation, see provisionally
also [H03H 11/1217](#) to [H03H 11/1252](#)

H03H 11/126 {using a single operational amplifier ([H03H 11/1204](#) takes
precedence; parallel-T filters [H03H 11/1295](#))}

H03H 11/1265 {Synthesis ([H03H 11/1269](#) to [H03H 11/1282](#) take precedence)}

H03H 11/1269 {Filters using the operational amplifier pole}

H03H 11/1273 {Modifications to reduce sensitivity}

H03H 11/1278 {Modifications to reduce detrimental influences of amplifier
imperfections, e.g. limited gain-bandwidth product, limited input
impedance}

H03H 11/1282 {Modifications to reduce influence of variations of temperature}

H03H 11/1286 {Sallen-Key biquad}

WARNING

Not complete, pending reorganisation, see provisionally also
[H03H 11/126](#) to [H03H 11/1282](#)

H03H 11/1291 {Current or voltage controlled filters}

H03H 11/1295 {Parallel-T filters}

H03H 11/14 using electro-optic devices

H03H 11/16 Networks for phase shifting

H03H 11/18 Two-port phase shifters providing a predetermined phase shift, e.g. "all-
pass" filters

H03H 11/20 Two-port phase shifters providing an adjustable phase shift

H03H 11/22 providing two or more phase shifted output signals, e.g. n-phase output

H03H 11/24 Frequency-independent attenuators

H03H 11/245 {using field-effect transistor}

H03H 11/26 Time-delay networks ([analogue shift registers G11C 27/04](#))

H03H 11/265 {with adjustable delay}

H03H 11/28 Impedance matching networks

H03H 11/30 Automatic matching of source impedance to load impedance

H03H 11/32 Balance-unbalance networks

H03H 11/34 Networks for connecting several sources or loads working on different
frequencies or frequency bands, to a common load or source ([for use in
multiplex transmission systems H04J 1/00](#))

H03H 11/342 {particularly adapted for use in common antenna systems}

H03H 11/344 {Duplexers}

H03H 11/346 {particularly adapted as input circuit for receivers}

- H03H 11/348 . . . {particularly adapted as coupling circuit between transmitters and antenna}
- H03H 11/36 . . Networks for connecting several sources or loads, working on the same frequency band, to a common load or source ([phase shifters providing two or more output signals H03H 11/22](#))
- H03H 11/362 . . . {particularly adapted for use in common antenna systems}
- H03H 11/365 . . . {particularly adapted as input circuit for receivers}
- H03H 11/367 . . . {particularly adapted as coupling circuit between transmitters and antenna}
- H03H 11/38 . . One-way transmission networks, i.e. unilines
- H03H 11/40 . . Impedance converters
- H03H 11/405 . . . {Positive impedance converters ([H03H 11/42](#) takes precedence; used in frequency selective networks [H03H 11/0416](#))}
- H03H 11/42 . . . Gytrators ([used in frequency selective networks H03H 11/08](#))
- H03H 11/44 . . . Negative impedance converters ([H03H 11/42](#) takes precedence; used in frequency selective networks [H03H 11/10](#))
- H03H 11/46 . One-port networks
- H03H 11/48 . . simulating reactances
- H03H 11/481 . . . {Simulating capacitances}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/483 . . . {Simulating capacitance multipliers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/485 . . . {Simulating inductances using operational amplifiers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/486 . . . {Simulating inductances using transconductance amplifiers}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/488 . . . {Simulating inductances using current conveyors}
- WARNING**
Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/50 . . . using gyrators
- H03H 11/52 . . simulating negative resistances

- H03H 11/525
 - . . . {Simulating frequency dependent negative resistance [FDNR]}
 - WARNING**
 - Not complete, pending reorganisation, see provisionally also [H03H 11/52](#)
- H03H 11/53
 - . . {simulating resistances; simulating resistance multipliers}
 - WARNING**
 - Not complete, pending reorganisation, see provisionally also [H03H 11/48](#) to [H03H 11/52](#)
- H03H 11/54
 - . Modifications of networks to reduce influence of variations of temperature
- H03H 15/00**
 - Transversal filters** (electromechanical filters [H03H 9/46](#), [H03H 9/70](#))
- H03H 2015/002
 - . {Computation saving measures}
- H03H 2015/005
 - . {comprising capacitors implemented with MEMS technology}
- H03H 2015/007
 - . {Programmable filters}
- H03H 15/02
 - . using analogue shift registers
- H03H 15/023
 - . . {with parallel-input configuration}
- H03H 2015/026
 - . {Matched filters in charge domain}
- H03H 17/00**
 - Networks using digital techniques**
- H03H 17/0009
 - . {Time-delay networks}
- H03H 17/0018
 - . . {Realizing a fractional delay}
- H03H 17/0027
 - . . . {by means of a non-recursive filter}
- H03H 17/0036
 - . . . {by means of a recursive filter}
- H03H 17/0045
 - . {Impedance matching networks}
- H03H 17/0054
 - . {Attenuators}
- H03H 17/0063
 - . {R, L, C, simulating networks}
- H03H 2017/0072
 - . {Theoretical filter design}
- H03H 2017/0081
 - . . {of FIR filters}
- H03H 2017/009
 - . . {of IIR filters}
- H03H 17/02
 - . Frequency selective networks {(digital computers for complex mathematical operations [G06F 17/10](#))}
- H03H 17/0201
 - . . {Wave digital filters}
- H03H 17/0202
 - . . {Two or more dimensional filters; Filters for complex signals (multidimensional convolutions [G06F 17/153](#))}
- H03H 2017/0204
 - . . . {Comb filters}
- H03H 2017/0205
 - . . . {Kalman filters}
- H03H 2017/0207
 - . . . {Median filters}
- H03H 2017/0208
 - . . . {using neural networks}
- H03H 2017/021
 - . . . {Wave digital filters}

H03H 17/0211	. . {using specific transformation algorithms, e.g. WALSH functions, Fermat transforms, Mersenne transforms, polynomial transforms, Hilbert transforms (correlation computation G06F 17/156)}
H03H 17/0213	. . . {Frequency domain filters using Fourier transforms}
H03H 2017/0214 {with input-sampling frequency and output-delivery frequency which differ, e.g. interpolation, extrapolation; anti-aliasing}
H03H 17/0216	. . . {Quefrequency domain filters}
H03H 17/0217	. . . {Number theoretic transforms}
H03H 17/0219	. . {Compensation of undesirable effects, e.g. quantisation noise, overflow (stability problems H03H 17/0461)}
H03H 2017/022	. . . {Rounding error}
H03H 2017/0222	. . . {Phase error}
H03H 17/0223	. . {Computation saving measures; Accelerating measures (computations per se G06F)}
H03H 17/0225	. . . {Measures concerning the multipliers}
H03H 17/0226 {comprising look-up tables}
H03H 17/0227	. . . {Measures concerning the coefficients}
H03H 17/0229 {reducing the number of taps}
H03H 17/023 {reducing the wordlength, the possible values of coefficients}
H03H 2017/0232 {Canonical signed digit [CSD] or power of 2 coefficients}
H03H 17/0233	. . . {Measures concerning the signal representation}
H03H 17/0235 {reducing the wordlength of signals}
H03H 17/0236 {using codes}
H03H 17/0238	. . . {Measures concerning the arithmetic used (performing computations G06F 7/60)}
H03H 17/0239 {Signed digit arithmetic}
H03H 17/0241 {Distributed arithmetic}
H03H 17/0242 {Residue number arithmetic}
H03H 2017/0244	. . . {Measures to reduce settling time}
H03H 2017/0245	. . . {Measures to reduce power consumption (H03H 17/0223 takes precedence)}
H03H 2017/0247	. . . {Parallel structures using a slower clock}
H03H 17/0248	. . {Filters characterised by a particular frequency response or filtering method}
H03H 17/025	. . . {Notch filters}
H03H 17/0251	. . . {Comb filters}
H03H 17/0252	. . . {Elliptic filters}
H03H 17/0254	. . . {Matched filters}
H03H 17/0255	. . . {Filters based on statistics (adaptive filters H03H 21/0029)}
H03H 17/0257 {KALMAN filters}
H03H 17/0258 {ARMA filters}
H03H 17/026	. . . {Averaging filters}
H03H 17/0261	. . . {Non linear filters}

H03H 17/0263 {Rank order filters}
H03H 17/0264	. . . {Filter sets with mutual related characteristics}
H03H 17/0266 {Filter banks}
H03H 17/0267 {comprising non-recursive filters}
H03H 17/0269 {comprising recursive filters}
H03H 17/027 {Complementary filters; Phase complementary filters}
H03H 17/0272 {Quadrature mirror filters}
H03H 17/0273 {Polyphase filters}
H03H 17/0275 {comprising non-recursive filters}
H03H 17/0276 {having two phases}
H03H 17/0277 {comprising recursive filters}
H03H 17/0279 {having two phases}
H03H 17/028	. . . {Polynomial filters}
H03H 17/0282	. . . {Sinc or gaussian filters (H03H 17/0671 takes precedence)}
H03H 17/0283	. . {Filters characterised by the filter structure (H03H 17/0202 , H03H 17/0219 to H03H 17/0248 take precedence)}
H03H 17/0285	. . . {Ladder or lattice filters}
H03H 17/0286	. . . {Combinations of filter structures}
H03H 17/0288 {Recursive, non-recursive, ladder, lattice structures}
H03H 17/0289 {Digital and active filter structures}
H03H 17/0291 {Digital and sampled data filters}
H03H 17/0292	. . . {Time multiplexed filters; Time sharing filters}
H03H 17/0294	. . {Variable filters; Programmable filters}
H03H 2017/0295	. . . {Changing between two filter characteristics}
H03H 2017/0297	. . . {Coefficients derived from input parameters}
H03H 2017/0298	. . {DSP implementation}
H03H 17/04	. . Recursive filters
H03H 17/0405	. . . {comprising a ROM addressed by the input and output data signals}
H03H 17/0411	. . . {using DELTA modulation}
H03H 17/0416	. . . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; Anti-aliasing}
H03H 17/0422 {the input and output signals being derived from two separate clocks, i.e. asynchronous sample rate conversion}
H03H 17/0427 {characterized by the ratio between the input-sampling and output-delivery frequencies}
H03H 17/0433 {the ratio being arbitrary or irrational}
H03H 17/0438 {the ratio being integer}
H03H 17/0444 {where the output-delivery frequency is higher than the input sampling frequency, i.e. interpolation}
H03H 17/045 {where the output-delivery frequency is lower than the input sampling frequency, i.e. decimation}
H03H 17/0455 {the ratio being rational}

H03H 17/0461	. . . {Quantisation; Rounding; Truncation; Overflow oscillations or limit cycles eliminating measures}
H03H 2017/0466 {Reduction of limit cycle oscillation}
H03H 2017/0472	. . . {based on allpass structures}
H03H 2017/0477	. . . {Direct form I}
H03H 2017/0483 {Transposed}
H03H 2017/0488	. . . {Direct form II}
H03H 2017/0494 {Transposed}
H03H 17/06	. . Non-recursive filters
H03H 17/0607	. . . {comprising a ROM addressed by the input data signals}
H03H 17/0614	. . . {using Delta-modulation}
H03H 17/0621	. . . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; Anti-aliasing}
H03H 17/0628 {the input and output signals being derived from two separate clocks, i.e. asynchronous sample rate conversion}
H03H 17/0635 {characterized by the ratio between the input-sampling and output-delivery frequencies}
H03H 17/0642 {the ratio being arbitrary or irrational}
H03H 17/065 {the ratio being integer}
H03H 17/0657 {where the output-delivery frequency is higher than the input sampling frequency, i.e. interpolation}
H03H 17/0664 {where the output-delivery frequency is lower than the input sampling frequency, i.e. decimation}
H03H 17/0671 {Cascaded integrator-comb [CIC] filters}
H03H 2017/0678 {with parallel structure, i.e. parallel CIC [PCIC]}
H03H 17/0685 {the ratio being rational}
H03H 2017/0692	. . . {Transposed}
H03H 17/08	. Networks for phase shifting
H03H 19/00	Networks using time-varying elements, e.g. N-path filters
H03H 19/002	. {N-path filters}
H03H 19/004	. {Switched capacitor networks}
H03H 19/006	. . {simulating one-port networks}
H03H 19/008	. {with variable switch closing time}
H03H 21/00	Adaptive networks
H03H 21/0001	. {Analogue adaptive filters}
H03H 21/0003	. . {comprising CCD devices}
H03H 21/0005	. . {comprising SAW devices}
H03H 21/0007	. . {comprising switched capacitor [SC] devices}
H03H 2021/0009	. . {Details}
H03H 2021/001	. . . {Analog multipliers}

H03H 21/0012	. {Digital adaptive filters}
H03H 21/0014	. . {Lattice filters}
H03H 21/0016	. . {Non linear filters}
H03H 21/0018	. . {Matched filters}
H03H 21/002	. . {Filters with a particular frequency response (H03H 21/0014 to H03H 21/0018 take precedence)}
H03H 21/0021	. . . {Notch filters}
H03H 21/0023	. . . {Comb filters}
H03H 21/0025	. . {Particular filtering methods}
H03H 21/0027	. . . {filtering in the frequency domain}
H03H 21/0029	. . . {based on statistics}
H03H 21/003 {KALMAN filters}
H03H 21/0032 {ARMA filters}
H03H 2021/0034 {Blind source separation}
H03H 2021/0036 {of convolutive mixtures}
H03H 2021/0038 {of instantaneous mixtures}
H03H 2021/004 {using state space representation}
H03H 2021/0041	. . . {Subband decomposition}
H03H 21/0043	. . {Adaptive algorithms}
H03H 2021/0045	. . . {Equation error}
H03H 2021/0047 {Combined output and equation error}
H03H 2021/0049	. . . {Recursive least squares algorithm}
H03H 2021/005 {with forgetting factor}
H03H 2021/0052 {combined with stochastic gradient algorithm}
H03H 2021/0054 {Affine projection}
H03H 2021/0056	. . . {Non-recursive least squares algorithm [LMS]}
H03H 2021/0058 {Block LMS, i.e. in frequency domain}
H03H 2021/0059 {Delayed LMS}
H03H 2021/0061 {Normalized LMS [NLMS]}
H03H 2021/0063 {Proportionate NLMS}
H03H 2021/0065 {Sign-sign LMS}
H03H 21/0067	. . {Means or methods for compensation of undesirable effects}
H03H 2021/0069	. . . {Finite wordlength}
H03H 2021/007	. . {Computation saving measures; Accelerating measures}
H03H 2021/0072	. . . {Measures relating to the coefficients}
H03H 2021/0074 {Reduction of the update frequency}
H03H 2021/0076	. . . {Measures relating to the convergence time (H03H 2021/0072 takes precedence)}
H03H 2021/0078 {varying the step size}
H03H 2021/0079	. . . {using look-up tables}

- H03H 2021/0081 . . {Details}
- H03H 2021/0083 . . . {Shadow filter, i.e. one of two filters which are simultaneously adapted, wherein the results of adapting the shadow filter are used for adapting the other filter}
- H03H 2021/0085 . . {Applications}
- H03H 2021/0087 . . . {Prediction}
- H03H 2021/0089 . . . {System identification, i.e. modeling}
- H03H 2021/009 {with recursive filters}
- H03H 2021/0092 . . . {Equalization, i.e. inverse modeling}
- H03H 2021/0094 . . . {Interference Cancelling}
- H03H 2021/0096 . . {with input-sampling frequency and output-delivery frequency which differ, e.g. extrapolation; anti-aliasing}
- H03H 2021/0098 . {Adaptive filters comprising analog and digital structures}

H03H 2210/00**Indexing scheme relating to details of tunable filters**

- H03H 2210/01 . Tuned parameter of filter characteristics
- H03H 2210/012 . . Centre frequency; Cut-off frequency
- H03H 2210/015 . . Quality factor or bandwidth
- H03H 2210/017 . . Amplitude, gain or attenuation
- H03H 2210/02 . Variable filter component
- H03H 2210/021 . . Amplifier, e.g. transconductance amplifier
- H03H 2210/023 . . . Tuning of transconductance via tail current source
- H03H 2210/025 . . Capacitor
- H03H 2210/026 . . Inductor
- H03H 2210/028 . . Resistor
- H03H 2210/03 . Type of tuning
- H03H 2210/033 . . Continuous
- H03H 2210/036 . . Stepwise
- H03H 2210/04 . Filter calibration method
- H03H 2210/043 . . by measuring time constant
- H03H 2210/046 . . Master -slave

H03H 2218/00**Indexing scheme relating to details of digital filters**

- H03H 2218/02 . Coefficients
- H03H 2218/025 . . updated selectively, e.g. by, in the presence of noise, temporally cancelling the update and outputting a predetermined value
- H03H 2218/04 . In-phase and quadrature [I/Q] signals
- H03H 2218/06 . Multiple-input, multiple-output [MIMO]; Multiple-input, single-output [MISO]
- H03H 2218/08 . Resource sharing
- H03H 2218/085 . . Multipliers
- H03H 2218/10 . Multiplier and or accumulator units
- H03H 2218/12 . Signal conditioning

H03H 2218/14	<ul style="list-style-type: none">• Non-uniform sampling
H03H 2220/00	Indexing scheme relating to structures of digital filters
H03H 2220/02	<ul style="list-style-type: none">• Modular, e.g. cells connected in cascade
H03H 2220/04	<ul style="list-style-type: none">• Pipelined
H03H 2220/06	<ul style="list-style-type: none">• Systolic
H03H 2220/08	<ul style="list-style-type: none">• Variable filter length
H03H 2222/00	Indexing scheme relating to digital filtering methods
H03H 2222/02	<ul style="list-style-type: none">• using fuzzy logic
H03H 2222/04	<ul style="list-style-type: none">• using neural networks
H03H 2222/06	<ul style="list-style-type: none">• using wavelets
H03H 2240/00	Indexing scheme relating to filter banks
H03H 2250/00	Indexing scheme relating to dual- or multi-band filters
H03H 2260/00	Theory relating to impedance networks